

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
(Attorney Docket No. 4492P1050US; Client No. P96-0013)

Official

Applicant: Schmidt, Wayne J.
For: PLATING SYSTEM FOR SEMICONDUCTOR MATERIALS
Serial No.: 08/680,067
Filed: July 15, 1996
Examiner: William Leader
Art Unit: 1741

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SECOND PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Please add the following claims prior to substantive examination of the above-captioned patent application.

IN THE CLAIMS:

- E1
41. The workpiece processing apparatus of claim 40 and further comprising a fluid cup height adjustment mechanism disposed to adjust the height of the fluid cup with respect to the process bowl.
42. The workpiece processing apparatus of claim 40 where in the bowl leveler comprises first, second and third adjustment mechanisms disposed peripherally about the process bowl.